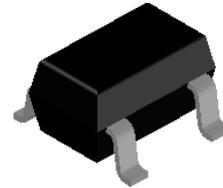


Features

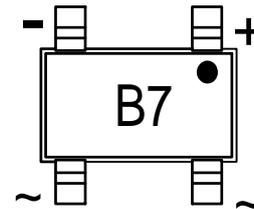
- Low profile space
- Ideal for printed circuit board
- Low reverse leakage
- Applied in power supply equipment
- High ring wave immunity capability
- High temperature soldering guaranteed:
260°C/10 seconds
- Component in accordance to
RoHS 2011/65/EU and WEEE 2002/96/EC



RoHS
COMPLIANT

Mechanical Data

- **Case:** IBS
The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- **Polarity:** Mark a dot at the positive position
The other end on the same side is negative
AC pole is on the other side
- **Mounting Position:** Any



Major Ratings and Characteristics

| | |
|-------------|---------------|
| $I_{F(AV)}$ | 0.5A |
| V_{RRM} | 400V to 1000V |
| I_{FSM} | 20A |
| V_F | 0.95V |
| $T_{Jmax.}$ | 125°C |

Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

| Items | Symbol | VMB054S | VMB056S | VMB058S | VMB0510S | Unit |
|--|-----------------------|-------------|---------|---------|----------|------------------|
| Maximum repetitive peak reverse voltage | V_{RRM} | 400 | 600 | 800 | 1000 | V |
| Maximum RMS voltage | V_{RMS} | 280 | 420 | 560 | 700 | V |
| Maximum DC blocking voltage | V_{DC} | 400 | 600 | 800 | 1000 | V |
| Average forward rectified current | $I_{F(AV)}$ | 0.5 | | | | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 20 | | | | A |
| Rating for fusing ($t < 8.3$ ms) | I^2t | 1.66 | | | | A ² s |
| Thermal resistance from junction to ambient | $R_{\theta JA}^{(1)}$ | 180 | | | | °C/W |
| Thermal resistance from junction to lead | $R_{\theta JL}$ | 35 | | | | |
| Operating junction and storage temperature range | T_J, T_{STG} | -55 to +125 | | | | |

Note 1: On 1.6mm thick glass epoxy P.C.B.(1OZ) mounted on 0.05 x 0.05" (1.3 x 1.3 mm) solder pads.

Electrical & Thermal Characteristics_ ($T_A = 25^\circ\text{C}$ unless otherwise noted)

| Items | Test conditions | Symbol | Min. | Typ. | Max. | Unit |
|-------------------------------|---|-------------------------|------|------|-------|------------------|
| Junction temperature | $I_F=0.10\text{A}, V_{\text{RMS}}=220\text{V}, T_A=25^\circ\text{C}$ and conduction angle= 80° | T_J | - | - | 70 | $^\circ\text{C}$ |
| Instantaneous forward voltage | $I_F=0.5\text{A}^{(2)}$ | V_F | - | 0.95 | 1.1 | V |
| Reverse current | $V_R=V_{\text{DC}}$ | $T_J=25^\circ\text{C}$ | - | - | 5.0 | μA |
| | | $T_J=125^\circ\text{C}$ | - | - | 100.0 | |

Note 2: Pulse test:300 μs pulse width,1% duty cycle.

Characteristics Curves

Fig.1 Foward Current Derating Curve

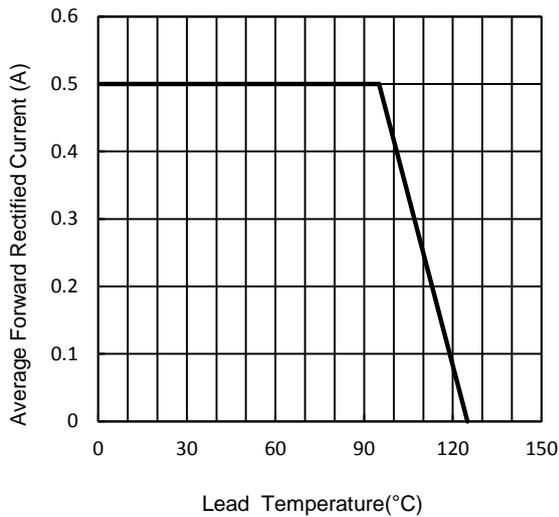
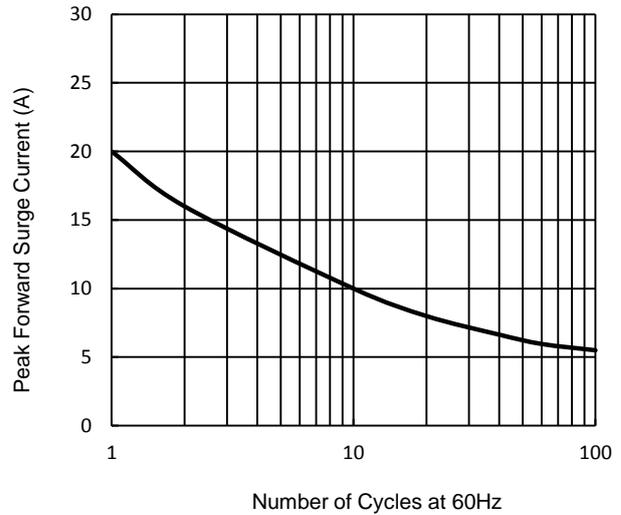


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current



Characteristics Curves

Fig.3 Typical Forward Current Characteristics

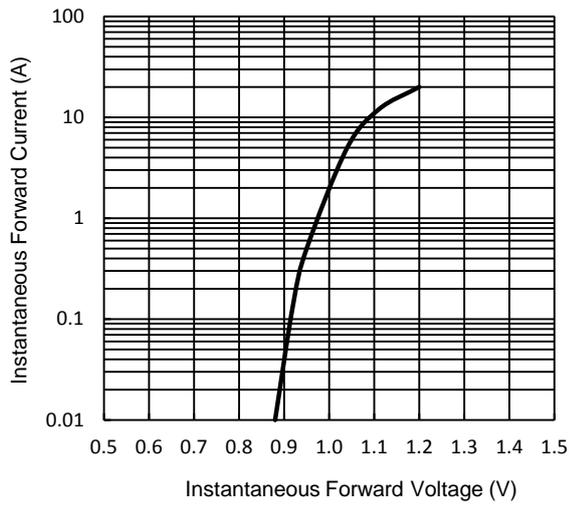


Fig.4 Typical Reverse Characteristics

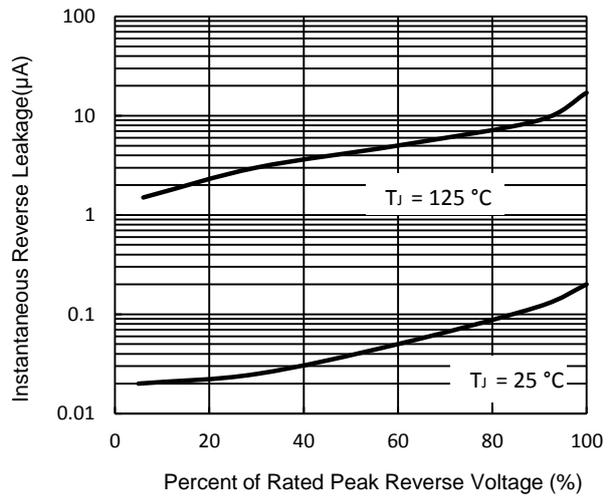
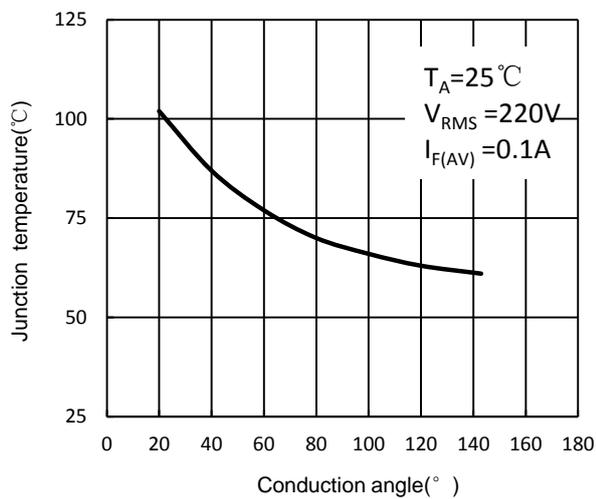
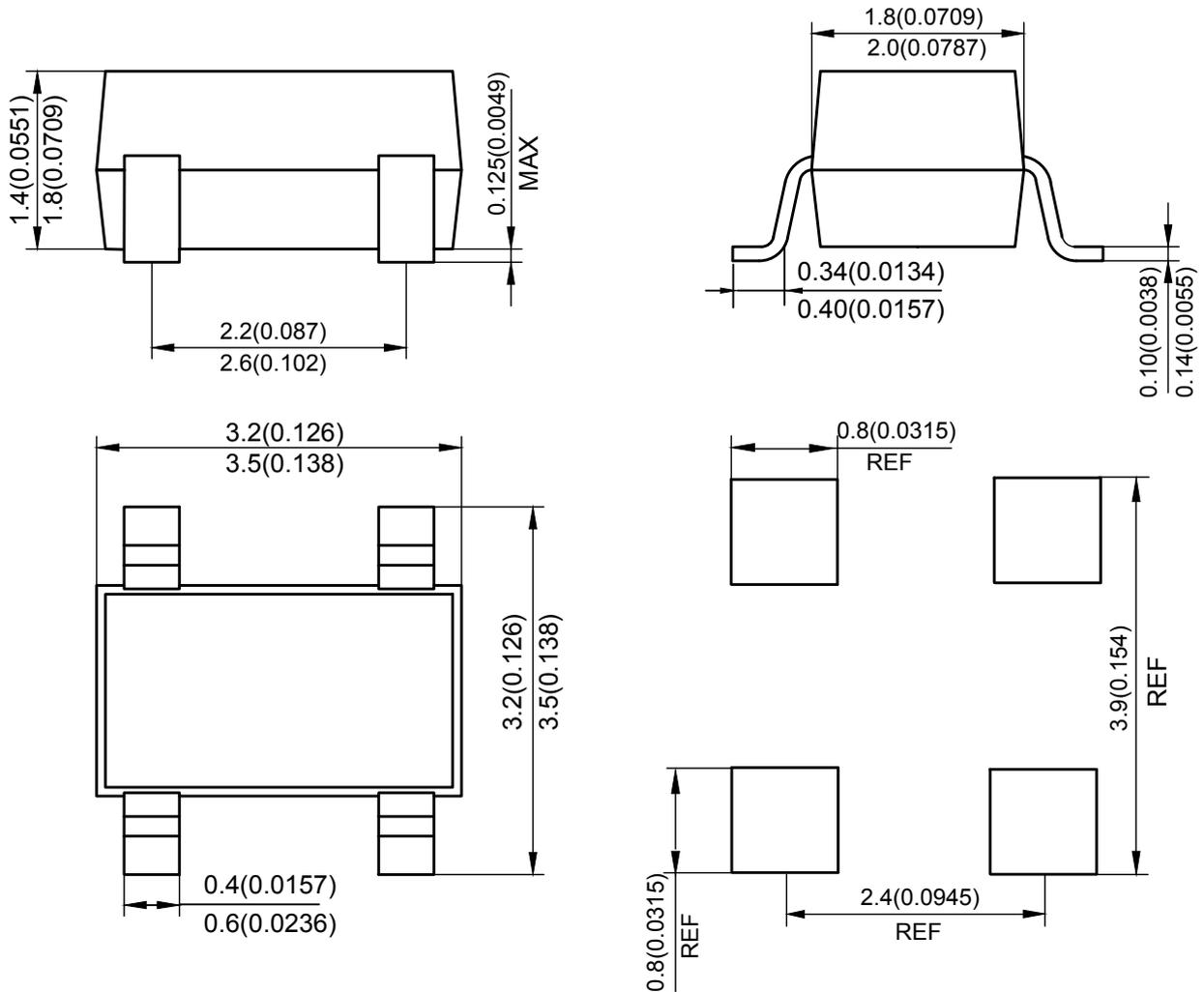


Fig.5 Junction temperature vs. conduction angle



Package Outline

IBS



Dimensions in millimeters(inches)